

USB Drive 3ME WP

Customer: _____

Customer

Part Number: _____

Innodisk

Part Number: _____

Innodisk

Model Name: _____

Date: _____

Innodisk Approver	Customer Approver

**The Total Solution For
Industrial Flash Storage**

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REVISION HISTORY

Revision	Description	Date
Pre.	First Release	Feb., 2020
V1.0	Official Release	Sep, 2020
V1.1	Change to black case	Jul., 2021
V1.2	Update PN rule table info. Revise storage temperature Remove Appendix	Oct., 2021
V1.3	Revise Mechanical Dimensions	Sep., 2022
V1.4	Revise product view and PN rule	Nov., 2022

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1. Product Overview

1.1 Introduction of USB Drive

The Innodisk USB Drive products provide high capacity USB flash memory storage that electrically complies with High-speed USB 3.0 interface & backward compatible with USB 2.0 and 1.1. The device features attractive small form factor and the connectivity over USB3.0 and the NAND flash architecture provide a faster data transmission. In our default setting, the USB Drive will be set up as "Removable mode". USB Drive 3ME WP product series support write protect function by removing write protect jumper.

1.2 Product View



Figure 1: USB Drive 3ME WP

1.3 Product Models

USB Drive 3ME WP is available in follow capacities.

- USB Drive 3ME WP 8GB
- USB Drive 3ME WP 16GB
- USB Drive 3ME WP 32GB
- USB Drive 3ME WP 64GB

1.4 Capacity

USB Drive 3ME WP provides unformatted from 8GB up to 64GB capacities within MLC Flash IC.

2. Theory of operation

2.1 Overview

Figure 2 shows the operation of USB Drive 3ME from the system level, including the major hardware blocks.

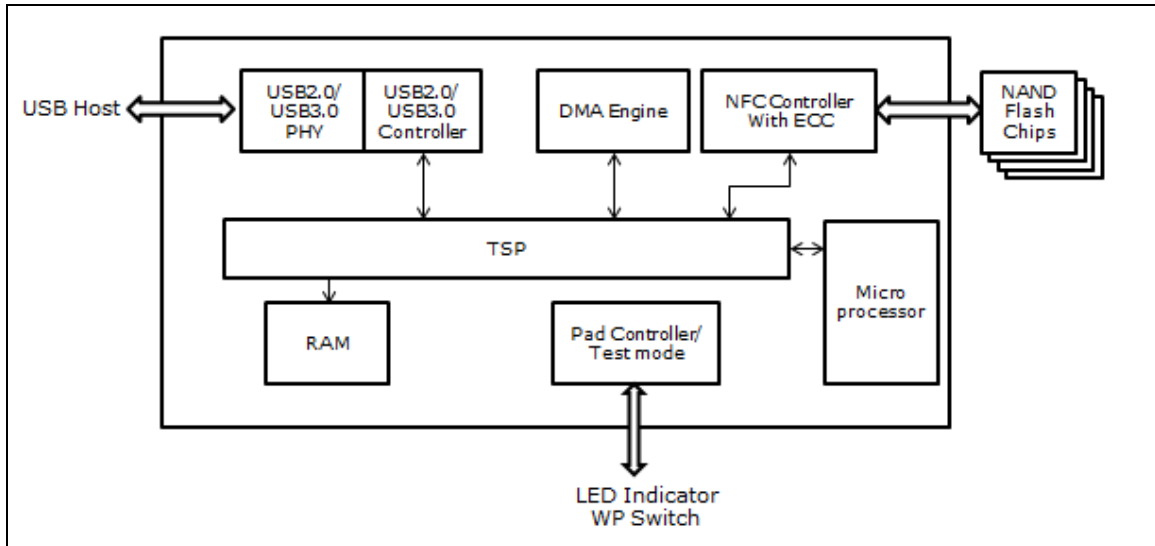


Figure 2: USB Drive 3ME WP Block Diagram

USB Drive 3ME WP integrates a USB3.0 controller and NAND flash memories. Communication with the host occurs through the host interface. Communication with the flash device(s) occurs through the flash interface.

2.2 Error Detection and Correction

Highly sophisticated Error Correction Code algorithms are implemented. The ECC unit consists of the Parity Unit (parity-byte generation) and the Syndrome Unit (syndrome-byte computation). This unit implements an algorithm that can correct 60 bits per 1024 bytes in an ECC block. Code-byte generation during write operations, as well as error detection during read operation, is implemented on the fly without any speed penalties.

2.3 Wear-Leveling

Flash memory can be erased within a limited number of times. This number is called the *erase cycle limit* or *write endurance limit* and is defined by the flash array vendor. The erase cycle limit applies to each individual erase block in the flash device.

USB Drive 3ME uses a static wear-leveling algorithm to ensure that consecutive writes of a specific sector are not written physically to the same page/block in the flash. This spreads flash media usage evenly across all pages, thereby extending flash lifetime.

2.4 Bad Blocks Management

Bad Blocks are blocks that contain one or more invalid bits whose reliability are not guaranteed. The Bad Blocks may be presented while the SSD is shipped, or may generate during the life time of the SSD. When the Bad Blocks is detected, it will be flagged, and not be used anymore. The SSD implement Bad Blocks management and replacement, Error Correct Code to avoid data error occurred. The functions will be enabled automatically to transfer data from Bad Blocks to spare blocks, and correct error bit. After the reserved block less than 40, the SSD will be locked, and cannot be written anymore.

3. Specifications

3.1 CE and FCC Compatibility

USB Drive 3ME WP conforms to CE and FCC requirements.

3.2 RoHS Compliance

USB Drive 3ME WP is fully compliant with RoHS directive.

3.3 Environmental Specifications

3.3.1 Temperature Ranges

Operating Temperature Range:

- Standard Grade: 0°C ~ +70°C
- Industrial Grade: -40°C ~ +85°C

Storage Temperature Range:

- Standard Grade: -40°C to +85°C

3.3.2 Humidity

Relative Humidity: 10-95%, non-condensing

3.3.3 Shock and Vibration

Reliability	Test Conditions	Reference Standards
Vibration	7 Hz to 2K Hz, 20G, 3 axes	IEC 68-2-6
Mechanical Shock	Duration: 0.5ms, 1500G, 3 axes	IEC 68-2-27

Table 1: Shock/Vibration Testing for USB Drive 3ME

3.3.4 Mean Time between Failures (MTBF)

Table 2 summarizes the MTBF prediction results for various USB Drive 3ME configurations. The analysis was performed using a RAM Commander™ failure rate prediction.

- Failure Rate: The total number of failures within an item population, divided by the total number of life units expended by that population, during a particular measurement interval under stated condition.
- Mean Time between Failures (MTBF): A basic measure of reliability for repairable items:

The mean number of life units during which all parts of the item perform within their specified limits, during a particular measurement interval under stated conditions.

Product	Condition	MTBF (Hours)
USB Drive 3ME	Telcordia SR-332 GB, 25°C	>3,000,000

Table 2: USB Drive 3ME MTBF

3.3.5 Terabyte Written (TBW)

Parameter	Value
TBW(Sequential Write)	Unit:TB
8GB	21.6
16GB	43.2
32GB	86.4
64GB	172.8

Table 3: USB Drive 3ME TBW

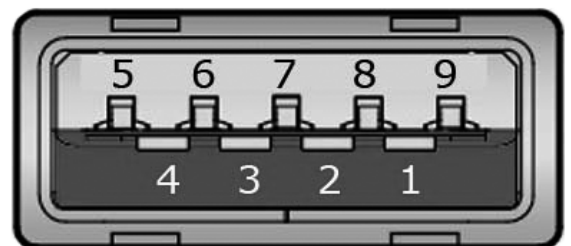
3.4 Golden finger

Au=30 μ”

3.5 Pin Assignment

USB Drive 3ME is designed within USB3.0 Interface. Particularly, its built-in power pin enables the device more compactable. Table 4 demonstrates USB Drive 3ME pin assignments.

Pin Number	Signal Name	Description
1	VBUS	Power
2	D-	USB 2.0 differential pair
3	D+	
4	GND	Ground for power return
5	StdA_SSRX-	SuperSpeed receiver differential pair
6	StdA_SSRX+	
7	GND_DRAIN	Ground for signal return
8	StdA_SSTX-	SuperSpeed transmitter differential pair
9	StdA_SSTX+	
Shell	Shield	Connector metal shell



Note: Tx and Rx are defined from the host perspective

Table 4: USB Drive 3ME WP Pin Assignment

3.6 Mechanical Dimensions

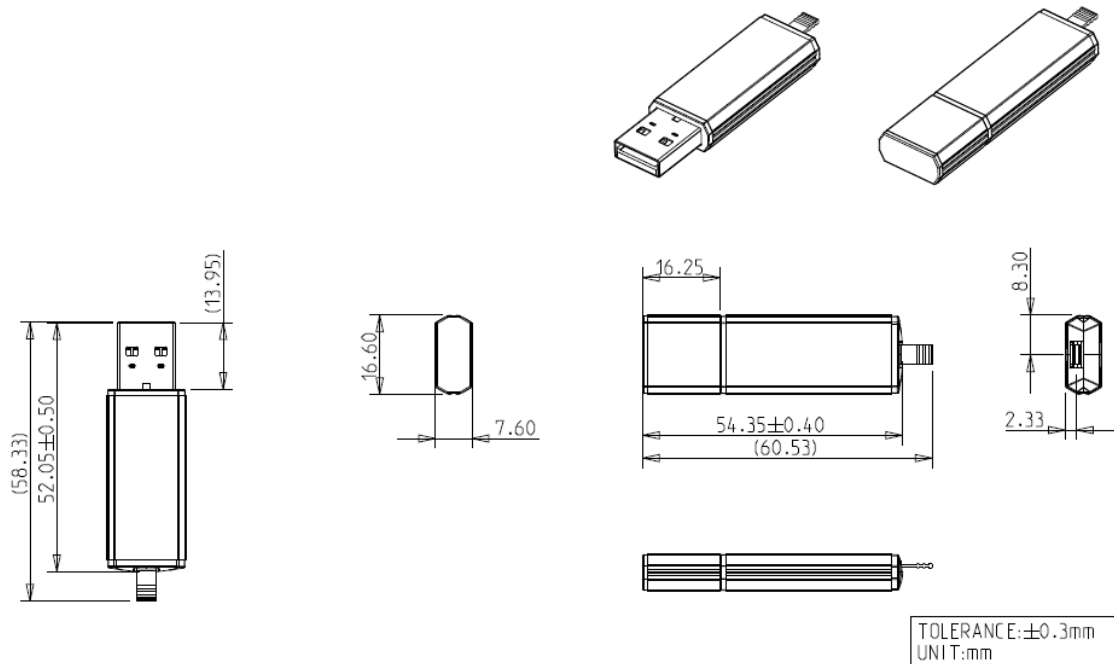


Figure 3: USB Drive 3ME WP mechanical dimensions

3.7 Weight

10g±2

3.8 Performance

Product name		8GB	16GB	32GB	64GB
USB Drive 3ME WP	Sequential Read (Max.)	100 MB/S	100 MB/S	100 MB/S	100 MB/S
	Sequential Write (Max.)	26 MB/S	26 MB/S	50 MB/S	50 MB/S

3.9 Write Protection function

USB Drive 3ME WP provides hardware write-protection (W/P) function that could prevent the device from modification and deletion. Write-protection function is enabled through plugging out W/P Jumper, making write-protected data to be read only, that is, users could not write to it, edit it, append data to it, or delete it. On the contrary, user could insert W/P jumper to disabled write protection function to write, edit or delete data.

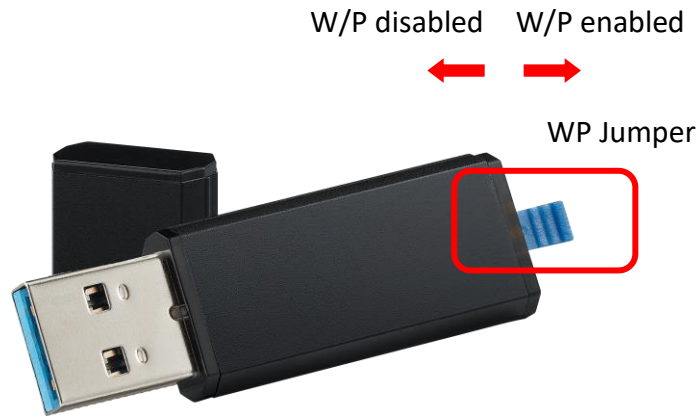


Figure 4: USB Drive 3ME WP functional demonstration

3.10 NAND Flash Memory

USB Drive 3ME WP uses Multi Level Cell (MLC) NAND flash memory, which is non-volatility and high reliability.

4. Electrical Specifications

4.1 Power Requirement

Item	Symbol	Rating	Unit
Input voltage	V _{IN}	+5 DC +- 5%	V

Table 5: USB Drive 3ME Power Requirement

4.2 Power Consumption

Mode	Power Consumption (mA)
Read(max. rms.)	111
Write(max. rms.)	136
Idle(max. rms.)	74

Table 6: Power Consumption

4.3 Device Parameters

Capacity	LBA	User capacity
8GB	15810560	7720MB
16GB	31686656	15472MB
32GB	63373312	30944MB
64GB	126812160	61920MB

Table 7: Device parameters

5. Part Number Rule

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
	D	E	U	A	1	-	0	8	G	I	6	1	B	C	3	S	C	-	x	x
Description	Disk	Form Factor			-	Capacity			Category			Flash mode	Operation Temp.	PCB Version	Channel	Flash		Customized Code		
Definition																				
Code 1st (Disk)											Code 14th (Operation Temperature)									
D: Disk											C: Standard Grade (0°C~ +70°C)									
Code 2nd ~ 5th (Form Factor)											W: Industrial Grade (-40°C~ +85°C)									
EUA1: USB Drive																				
											Code 15th (Internal control)									
Code 7th ~9th (Capacity)											1: Standard Version									
08G: 8GB											3: with W/P jumper									
16G: 16GB																				
32G: 32GB											Code 16th (Channel)									
64G: 64GB											S: Single									
Code 10th ~12th (Category)											Code 17th (Flash)									
I61: USB 3ME series											C: Kioxia MLC									
Code 13th (Flash mode)																				
B: Sync. Flash (15nm)																				